

STARPOWER**SEMICONDUCTOR****IGBT****GD75FSY120L3S****1200V/75A 6 in one-package****General Description**

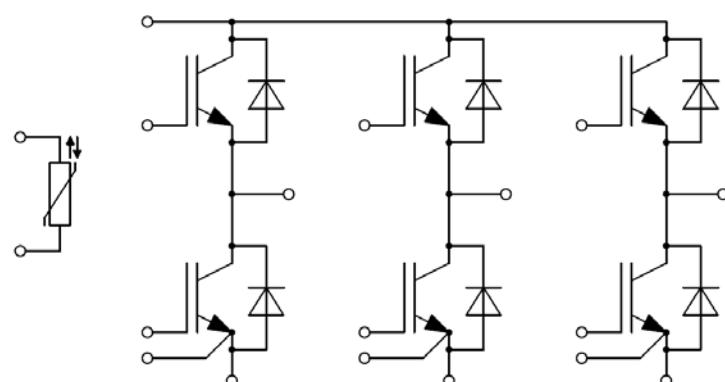
STARPOWER IGBT Power Module provides ultra low conduction loss as well as short circuit ruggedness. They are designed for the applications such as general inverters and UPS.

**Features**

- Low $V_{CE(sat)}$ Trench IGBT technology
- $10\mu\text{s}$ short circuit capability
- $V_{CE(sat)}$ with positive temperature coefficient
- Maximum junction temperature 175°C
- Low inductance case
- Fast & soft reverse recovery anti-parallel FWD
- Isolated heatsink using DBC technology

Typical Applications

- Inverter for motor drive
- AC and DC servo drive amplifier
- Uninterruptible power supply

Equivalent Circuit Schematic

Absolute Maximum Ratings $T_C=25^\circ\text{C}$ unless otherwise noted**IGBT**

Symbol	Description	Value	Unit
V_{CES}	Collector-Emitter Voltage	1200	V
V_{GES}	Gate-Emitter Voltage	± 20	V
I_C	Collector Current @ $T_C=25^\circ\text{C}$ @ $T_C=100^\circ\text{C}$	150 75	A
I_{CM}	Pulsed Collector Current $t_p=1\text{ms}$	150	A
P_D	Maximum Power Dissipation @ $T_i=175^\circ\text{C}$	576	W

Diode

Symbol	Description	Values	Unit
V_{RRM}	Repetitive Peak Reverse Voltage	1200	V
I_F	Diode Continuous Forward Current	75	A
I_{FM}	Diode Maximum Forward Current $t_p=1\text{ms}$	150	A

Module

Symbol	Description	Value	Unit
T_{jmax}	Maximum Junction Temperature	175	$^\circ\text{C}$
T_{jop}	Operating Junction Temperature	-40 to +150	$^\circ\text{C}$
T_{STG}	Storage Temperature Range	-40 to +125	$^\circ\text{C}$
V_{ISO}	Isolation Voltage RMS, $f=50\text{Hz}, t=1\text{min}$	2500	V

IGBT Characteristics $T_C=25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
$V_{CE(\text{sat})}$	Collector to Emitter Saturation Voltage	$I_C=75\text{A}, V_{GE}=15\text{V}, T_j=25^\circ\text{C}$		1.65	2.10	V
		$I_C=75\text{A}, V_{GE}=15\text{V}, T_j=125^\circ\text{C}$		1.95		
		$I_C=75\text{A}, V_{GE}=15\text{V}, T_j=150^\circ\text{C}$		2.00		
$V_{GE(\text{th})}$	Gate-Emitter Threshold Voltage	$I_C=1.88\text{mA}, V_{CE}=V_{GE}, T_j=25^\circ\text{C}$	5.2	6.0	6.8	V
I_{CES}	Collector Cut-Off Current	$V_{CE}=V_{CES}, V_{GE}=0\text{V}, T_j=25^\circ\text{C}$			1.0	mA
I_{GES}	Gate-Emitter Leakage Current	$V_{GE}=V_{GES}, V_{CE}=0\text{V}, T_j=25^\circ\text{C}$			100	nA
R_{Gint}	Internal Gate Resistance			2.0		Ω
C_{ies}	Input Capacitance	$V_{CE}=30\text{V}, f=1\text{MHz}, V_{GE}=0\text{V}$		7.15		nF
C_{res}	Reverse Transfer Capacitance			0.23		nF
Q_G	Gate Charge	$V_{GE}=-15\ldots+15\text{V}$		0.48		μC
$t_{d(on)}$	Turn-On Delay Time	$V_{CC}=600\text{V}, I_C=75\text{A}, R_G=5.1\Omega, V_{GE}=\pm 15\text{V}, T_j=25^\circ\text{C}$		219		ns
t_r	Rise Time			42		ns
$t_{d(off)}$	Turn-Off Delay Time			271		ns
t_f	Fall Time			261		ns
E_{on}	Turn-On Switching Loss			2.95		mJ
E_{off}	Turn-Off Switching Loss			4.70		mJ
$t_{d(on)}$	Turn-On Delay Time	$V_{CC}=600\text{V}, I_C=75\text{A}, R_G=5.1\Omega, V_{GE}=\pm 15\text{V}, T_j=125^\circ\text{C}$		220		ns
t_r	Rise Time			46		ns
$t_{d(off)}$	Turn-Off Delay Time			289		ns
t_f	Fall Time			397		ns
E_{on}	Turn-On Switching Loss			4.00		mJ
E_{off}	Turn-Off Switching Loss			7.65		mJ
$t_{d(on)}$	Turn-On Delay Time	$V_{CC}=600\text{V}, I_C=75\text{A}, R_G=5.1\Omega, V_{GE}=\pm 15\text{V}, T_j=150^\circ\text{C}$		222		ns
t_r	Rise Time			46		ns
$t_{d(off)}$	Turn-Off Delay Time			295		ns
t_f	Fall Time			410		ns
E_{on}	Turn-On Switching Loss			4.40		mJ
E_{off}	Turn-Off Switching Loss			8.41		mJ
I_{SC}	SC Data	$t_p \leq 10\mu\text{s}, V_{GE}=15\text{V}, T_j=150^\circ\text{C}, V_{CC}=900\text{V}, V_{CEM} \leq 1200\text{V}$		300		A

Diode Characteristics $T_C=25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
V_F	Diode Forward Voltage	$I_F=75\text{A}, V_{GE}=0\text{V}, T_j=25^\circ\text{C}$		1.70	2.15	V
		$I_F=75\text{A}, V_{GE}=0\text{V}, T_j=125^\circ\text{C}$		1.65		
		$I_F=75\text{A}, V_{GE}=0\text{V}, T_j=150^\circ\text{C}$		1.65		
Q_r	Recovered Charge	$V_R=600\text{V}, I_F=75\text{A}, -di/dt=1400\text{A}/\mu\text{s}, V_{GE}=-15\text{V}$ $T_j=25^\circ\text{C}$		5.0		μC
I_{RM}	Peak Reverse Recovery Current			81		A
E_{rec}	Reverse Recovery Energy			3.40		mJ
Q_r	Recovered Charge	$V_R=600\text{V}, I_F=75\text{A}, -di/dt=1400\text{A}/\mu\text{s}, V_{GE}=-15\text{V}$ $T_j=125^\circ\text{C}$		11.0		μC
I_{RM}	Peak Reverse Recovery Current			97		A
E_{rec}	Reverse Recovery Energy			6.02		mJ
Q_r	Recovered Charge	$V_R=600\text{V}, I_F=75\text{A}, -di/dt=1400\text{A}/\mu\text{s}, V_{GE}=-15\text{V}$ $T_j=150^\circ\text{C}$		12.5		μC
I_{RM}	Peak Reverse Recovery Current			106		A
E_{rec}	Reverse Recovery Energy			6.62		mJ

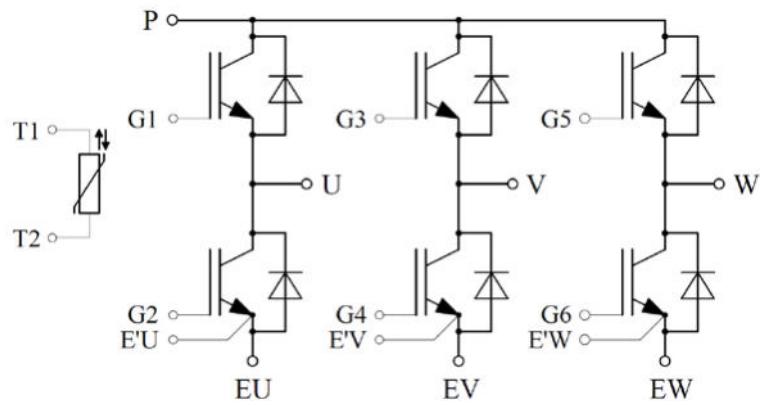
NTC Characteristics $T_C=25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
R_{25}	Rated Resistance			5.0		$\text{k}\Omega$
$\Delta R/R$	Deviation of R_{100}	$T_C=100^\circ\text{C}, R_{100}=493.3\Omega$	-5		5	%
P_{25}	Power Dissipation				20.0	mW
$B_{25/50}$	B-value	$R_2=R_{25}\exp[B_{25/50}(1/T_2 - 1/(298.15\text{K}))]$		3375		K

Module Characteristics $T_C=25^\circ\text{C}$ unless otherwise noted

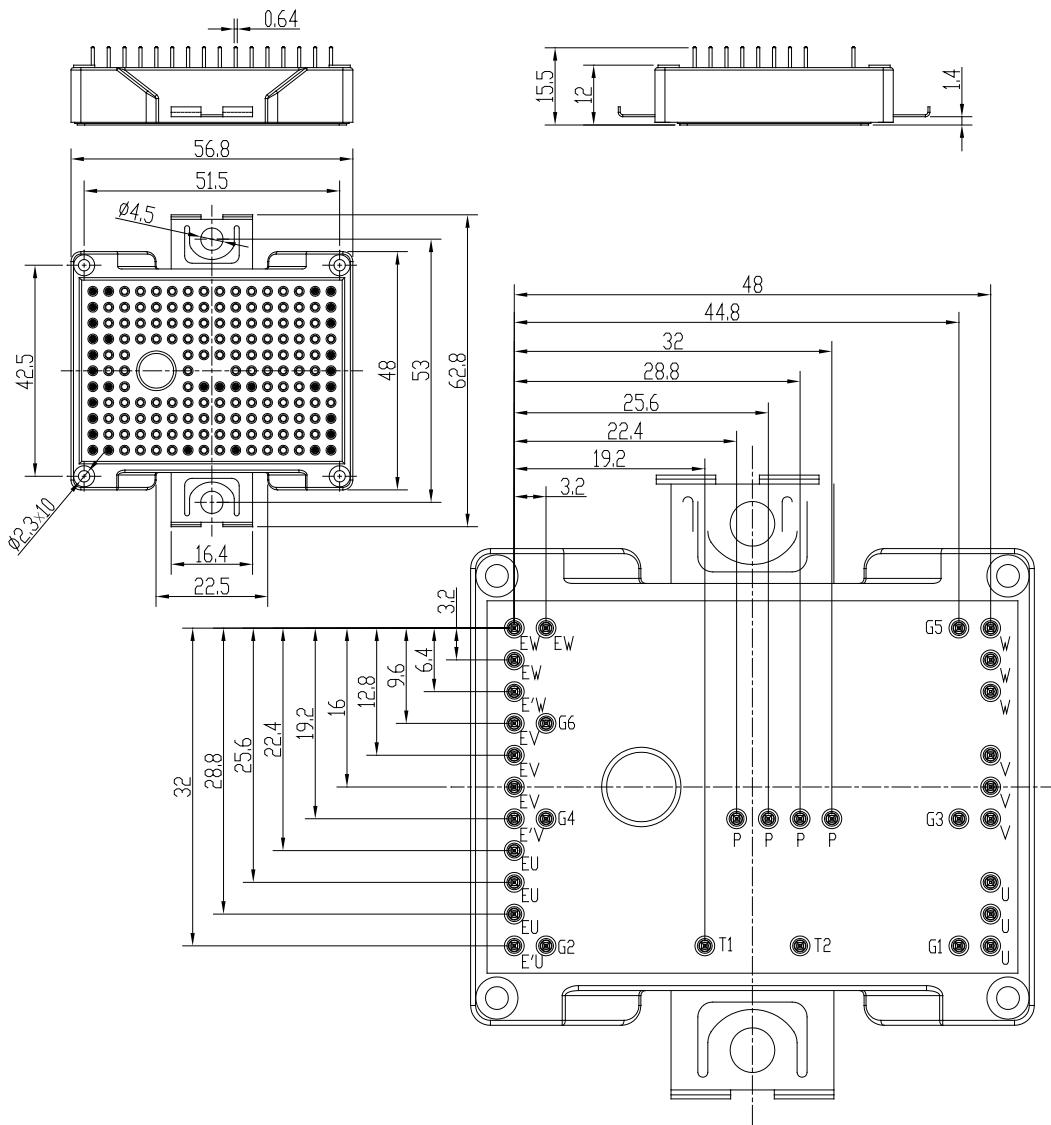
Symbol	Parameter	Min.	Typ.	Max.	Unit
L_{CE}	Stray Inductance		40		nH
R_{CC+EE}	Module Lead Resistance, Terminal to Chip		4.00		$\text{m}\Omega$
R_{thJC}	Junction-to-Case (per IGBT) Junction-to-Case (per Diode)		0.236 0.405	0.260 0.446	K/W
R_{thCH}	Case-to-Heatsink (per IGBT) Case-to-Heatsink (per Diode) Case-to-Heatsink (per Module)		0.351 0.603 0.037		K/W
F	Mounting Force Per Clamp	40		80	N
G	Weight of Module		39		g

Circuit Schematic



Package Dimensions

Dimensions in Millimeters



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